

J Series® 2835 3-V N Class Precision Dimming LED



PRODUCT DESCRIPTION

J Series® 2835 LEDs combine high efficacy and excellent value in a reliable package. The J Series 2835 LEDs are optimized for low-density lighting applications where high efficacy and smooth appearance are critical, such as downlights, troffers, and panel lights.

Precision Dimming provides a simplified approach to address the issue of unacceptable LED light output and hue variations when using low-current dimming. Unlike competing solutions that just control for voltage, Precision Dimming controls for voltage as well as color rendering metrics, including CRI and TM-30 Rf.

FEATURES

- Industry-compatible size: 2.8 x 3.5 x 0.7 mm
- · 3-V configuration
- · Flux and chromaticity binned at 25 °C
- 6500 K-2700 K ANSI CCTs available
- · 80 & 90 CRI minimum available

PRODUCT SUMMARY

Product	Power	Test	Test	Typical	4000 K	, 80 CRI	Maximum
		Temperature Current		Forward Voltage	Typical Flux	Typical Efficacy	Current
JE2835B 3-V N Class Precision Dimming	0.5 W	25 °C	150 mA	2.86 V	78.1 lm	182 LPW	240 mA

Cree LED / 4001 E. Hwy. 54, Suite 2000 / Durham, NC 27709 USA / +1.919.313.5330 / www.cree-led.com

J Series® Products are sold exclusively by Cree Venture LED Company Limited ("Cree Venture"), regardless of geography. Any orders for J Series Products that are submitted to Cree LED or any of its other subsidiaries will be directed to Cree Venture for acknowledgment and order fulfillment.

J SERIES® 2835 3-V N CLASS PRECISION DIMMING LED



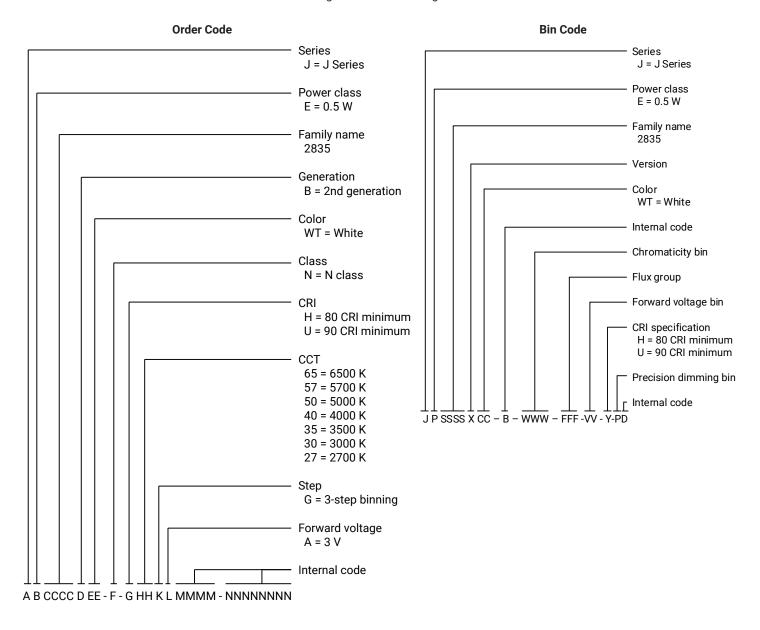
TABLE OF CONTENTS

Order Code & Bin Code Formats	3
Characteristics	4
Operating Limits	4
Flux Characteristics, Order Codes and Bins	5
Relative Luminous Flux vs. Current	6
Electrical Characteristics	6
Relative Chromaticity vs. Current	7
Relative Chromaticity vs. Temperature	7
Relative Luminous Flux vs. Junction Temperature	8
Relative Spectral Power Distribution	9
Typical Spatial Distribution	10
Performance Groups - Luminous Flux	11
Performance Groups - Forward Voltage	11
Performance Groups - Chromaticity	12
Reflow Soldering Characteristics	20
Notes	21
Mechanical Dimensions	23
Tape & Reel	24
Packaging	26



ORDER CODE & BIN CODE FORMATS

Order codes and bin codes for J Series 2835 LEDs are configured in the following manner:





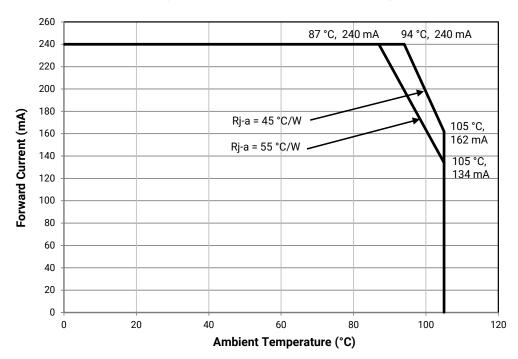
CHARACTERISTICS

Characteristics	Unit	Minimum	Typical	Maximum
Thermal resistance, junction to solder point	°C/W		11	
Viewing angle (FWHM)	degrees		120	
Temperature coefficient of voltage	mV/°C		-1.4	
ESD withstand voltage (HBM per Mil-Std-883L)			Class 2	
DC forward current	mA			240
Reverse voltage	V			5
Forward voltage (@ 150 mA, 25 °C)	V		2.86	3.0
LED junction temperature	°C			125
Operating temperature	°C	-40		105

· Continuous reverse voltage can cause LED damage.

OPERATING LIMITS

The maximum forward current is determined by the thermal resistance between the LED junction and ambient.





FLUX CHARACTERISTICS, ORDER CODES AND BINS ($I_F = 150 \text{ mA}, T_i = 25 \text{ °C}$)

The following table provides order codes for J Series JE2835B 3-V N Class Precision Dimming LEDs. For a complete description of the order code nomenclature, please see the Order Code and Bin Code Formats section (page 3). For definitions of the chromaticity kits, please see the Performance Groups - Chromaticity section (page 12).

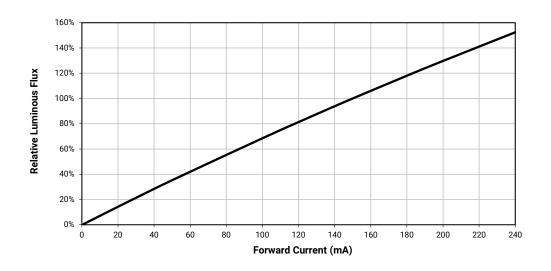
Nominal CCT	Minimum CRI	Typical Flux (lm) @ 25 °C	Flux Groups	Forward Voltage Bins	Precision Dimming Bins	Order Code		
6500 K	80	77.1	H7, H8	AD, AE	L, M	JE2835BWT-N-H65GAP001-N00A0001		
0500 K	90	66.0	G7, G8	AD, AE	L, M	JE2835BWT-N-U65GAP001-N00A0001		
5700 K	80	78.1	H7, H8	AD, AE	L, M	JE2835BWT-N-H57GAP001-N00A0001		
3700 K	90	66.0	G7, G8	AD, AE	L, M	JE2835BWT-N-U57GAP001-N00A0001		
E000 K	80	78.1	H7, H8	AD, AE	K, L	JE2835BWT-N-H50GAP001-N00A0001		
5000 K	90	66.0	G7, G8	AD, AE	L, M	JE2835BWT-N-U50GAP001-N00A0001		
4000 K	80	78.1	H7, H8	AD, AE	K, L	JE2835BWT-N-H40GAP001-N00A0001		
4000 K	90	66.0	G7, G8	AD, AE	L, M	JE2835BWT-N-U40GAP001-N00A0001		
3500 K	80	75.8	H6, H7	AD, AE	J, K	JE2835BWT-N-H35GAP001-N00A0001		
3300 K	90	64.2	G7, G8	AD, AE	L, M	JE2835BWT-N-U35GAP001-N00A0001		
3000 K	80	73.8	H6, H7	AD, AE	J, K	JE2835BWT-N-H30GAP001-N00A0001		
3000 K	90	62.1	G6, G7	AD, AE	K, L	JE2835BWT-N-U30GAP001-N00A0001		
2700 K	80	70.7	G9, H6	AD, AE	J, K	JE2835BWT-N-H27GAP001-N00A0001		
2700 K	90	59.3	F9, G6	AD, AE	K, L	JE2835BWT-N-U27GAP001-N00A0001		

Notes:

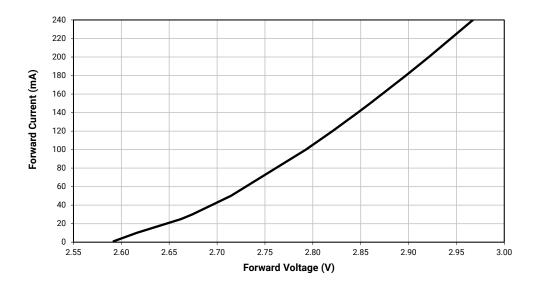
Cree Venture maintains a tolerance of ±7% on flux and power measurements, ±0.005 on chromaticity (CCx, CCy) measurements and ±2 on CRI measurements. See the Measurements section (page 21).



RELATIVE LUMINOUS FLUX VS. CURRENT

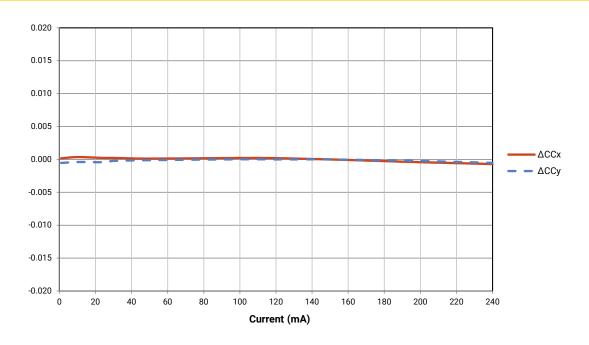


ELECTRICAL CHARACTERISTICS

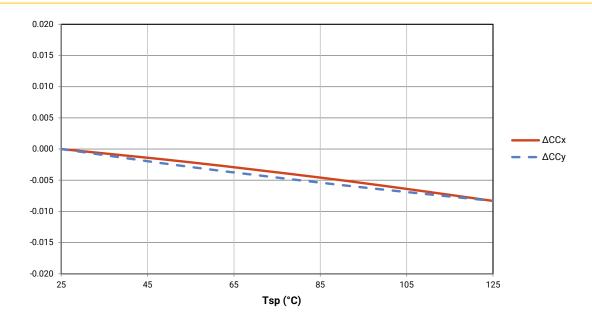




RELATIVE CHROMATICITY VS. CURRENT

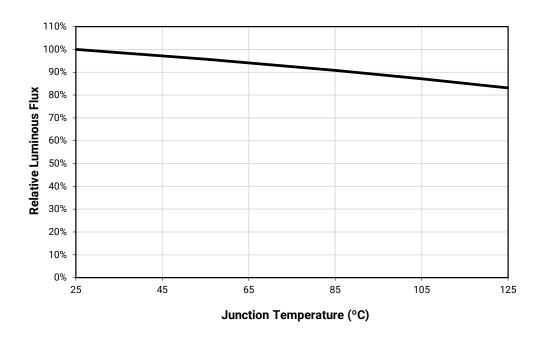


RELATIVE CHROMATICITY VS. TEMPERATURE



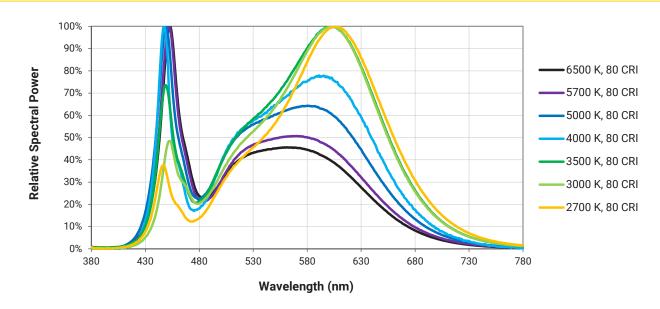


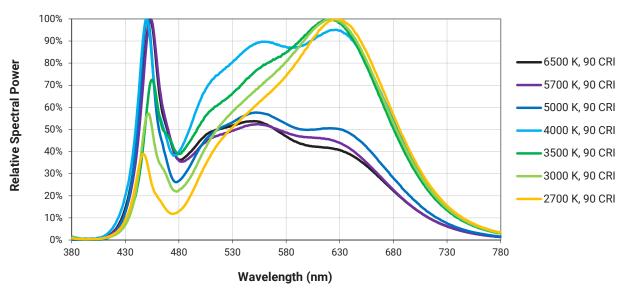
RELATIVE LUMINOUS FLUX VS. JUNCTION TEMPERATURE





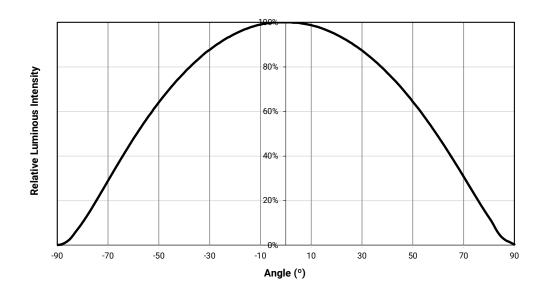
RELATIVE SPECTRAL POWER DISTRIBUTION







TYPICAL SPATIAL DISTRIBUTION





PERFORMANCE GROUPS - LUMINOUS FLUX ($T_j = 25$ °C)

J Series JE2835B 3-V N Class Precision Dimming LEDs are tested for luminous flux at 150 mA and placed into one of the following luminous-flux groups.

Group Code	Minimum Luminous Flux (lm)	Maximum Luminous Flux (lm)
F9	57	60
G6	60	63
G7	63	66
G8	66	69
G9	69	72
H6	72	75
H7	75	78
H8	78	81

PERFORMANCE GROUPS - FORWARD VOLTAGE (T $_{\rm j}$ = 25 °C)

J Series 2835 LEDs are tested for forward voltage and placed into one of the following voltage bins.

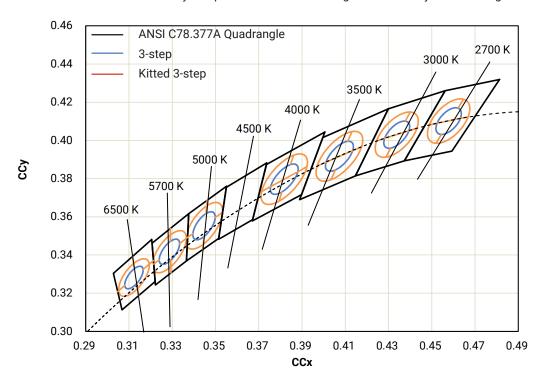
The following voltage bins are indicated in the Forward Voltage Bin field in the bin code for JE2835B 3-V N Class Precision Dimming LEDs.

Voltage Bin	Minimum Forward Voltage (V)	Maximum Forward Voltage (V)
AD	2.7	2.8
AE	2.8	2.9

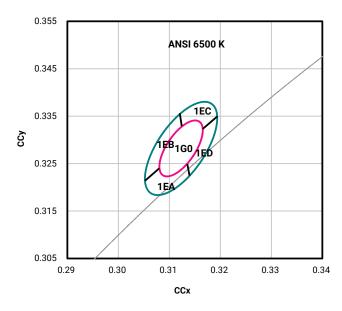


PERFORMANCE GROUPS - CHROMATICITY ($T_i = 25$ °C)

J Series 2835 LEDs are tested for chromaticity and placed into one of the regions defined by the following bounding coordinates.

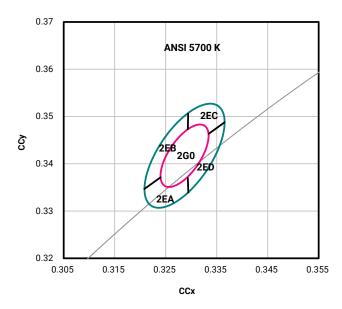






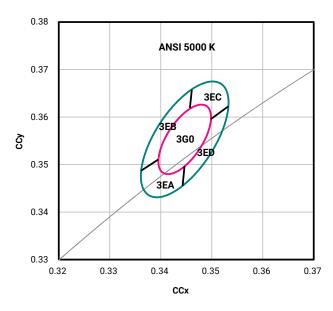
CCT MacAdam Ellipse	MacAdam Ellipse	lacAdam Ellipse Included Bins	Center Point		Major Axis	Minor Axis	Rotation Angle (°)
001	MacAdam Empse	iacAuain Empse included bills		у	а	b	Rotation Angle ()
	3-step	1G0	0.3123	0.3282	0.00669	0.00285	58.57
6500 K	Kitted 3-step	1G0, 1EA, 1EB, 1EC, 1ED	0.3123	0.3282	0.01115	0.00475	58.57





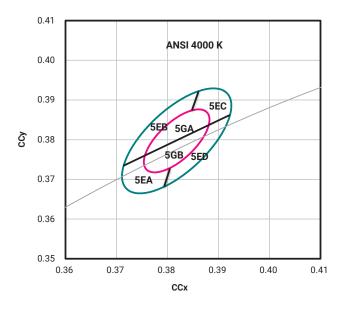
ССТ	CCT MacAdam Ellipse	MacAdam Ellipse Included Bins —		Center Point		Minor Axis	Rotation Angle (°)
001				у	а	b	Notation Angle ()
	3-step	2G0	0.3287	0.3417	0.00746	0.00320	59.09
5700 K	Kitted 3-step	2G0, 2EA, 2EB, 2EC, 2ED	0.3287	0.3417	0.01243	0.00533	59.09





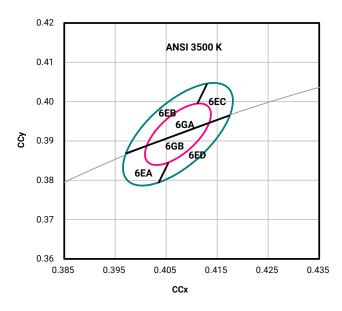
CCT MacAdam Ellipse	MacAdam Ellipse Included Bins	Cente	r Point	Major Axis	Minor Axis	Rotation Angle (°)	
001	MacAuam Empse	iliciadea Bilis	x	у	а	b	Rotation Angle ()
	3-step	3G0	0.3447	0.3553	0.00822	0.00354	59.62
5000 K	Kitted 3-step	3G0, 3EA, 3EB, 3EC, 3ED	0.3447	0.3553	0.01370	0.00590	59.62





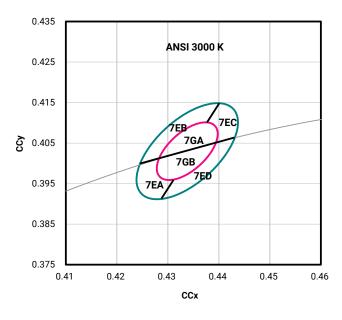
CCT	CCT MacAdam Ellipse Included E	MacAdam Ellinsa Included Rins		r Point	Major Axis	Minor Axis	Rotation Angle (°)
001		MacAdam Empse	iliciadea Bills	x	у	а	b
	3-step	5GA, 5GB	0.3818	0.3797	0.00939	0.00402	53.72
4000 K	Kitted 3-step	5GA, 5GB, 5EA, 5EB, 5EC, 5ED	0.3818	0.3797	0.01565	0.00670	53.72





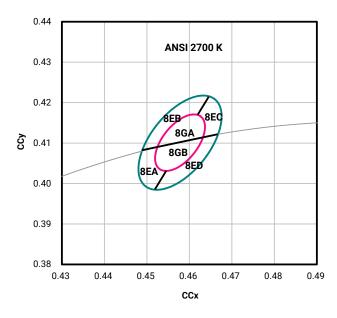
CCT	CCT MacAdam Ellipse I	Included Bins	Cente	r Point	Major Axis	Minor Axis	Rotation Angle (°)
CCI		macAdam Empse Included Bills		у	а	b	Rotation Angle ()
	3-step	6GA, 6GB	0.4073	0.3917	0.00927	0.00414	54.00
3500 K	Kitted 3-step	6GA, 6GB, 6EA, 6EB, 6EC, 6ED	0.4073	0.3917	0.01545	0.00690	54.00





CCT MacAdam Ellipse	Included Bins	Center Point		Major Axis	Minor Axis	Rotation Angle (°)	
001	MacAuam Empse	included bills	x	у	а	b	Rotation Angle ()
	3-step	7GA, 7GB	0.4338	0.4030	0.00834	0.00408	53.22
3000 K	Kitted 3-step	7GA, 7GB, 7EA, 7EB 7EC, 7ED	0.4338	0.4030	0.01390	0.00680	53.22





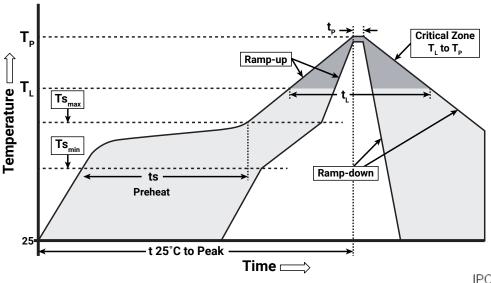
сст	MacAdam Ellipse	Included Bins	Center Point		Major Axis	Minor Axis	Rotation Angle (°)
			х	у	а	b	Rotation Angle ()
	3-step	8GA, 8GB	0.4578	0.4101	0.00810	0.00420	53.70
2700 K	Kitted 3-step	8GA, 8GB, 8EA, 8EB, 8EC, 8ED	0.4578	0.4101	0.01350	0.00700	53.70



REFLOW SOLDERING CHARACTERISTICS

In testing, Cree Venture has found J Series 2835 LEDs to be compatible with JEDEC J-STD-020C, using the parameters listed below. As a general guideline, Cree Venture recommends that users follow the recommended soldering profile provided by the manufacturer of the solder paste used, and therefore it is the lamp or luminaire manufacturer's responsibility to determine applicable soldering requirements.

Note that this general guideline may not apply to all PCB designs and configurations of reflow soldering equipment.



IPC/JEDEC J-STD-020C

Profile Feature	Lead-Free Solder
Temperature Min. (Ts _{min})	150 °C
Temperature Max. (Ts _{max})	200 °C
Time (ts) from Ts _{min} to Ts _{max}	60-120 seconds
Ramp-Up Rate $(T_L \text{ to } T_p)$	3 °C/second
Liquidus Temperature (T_L)	217 °C
Time (t _L) Maintained Above T _L	60-150 seconds
Peak Package Body Temperature (Tp)	260 °C max.
Time (tp) Within 5 °C of the Specified Classification Temperature (Tc)	30 seconds max.
Ramp-Down Rate $(T_p \text{ to } T_L)$	6 °C/second max.
Time 25 °C to Peak Temperature	8 minutes max.

Note: All temperatures refer to the topside of the package, measured on the package body surface.



NOTES

Measurements

The luminous flux, radiant power, chromaticity, forward voltage and CRI measurements in this document are binning specifications only and solely represent product measurements as of the date of shipment. These measurements will change over time based on a number of factors that are not within Cree Venture's control and are not intended or provided as operational specifications for the products. Calculated values are provided for informational purposes only and are not intended or provided as specifications.

Pre-Release Qualification Testing

Please read the J Series Reliability Overview for the details of the pre-release qualification testing for J Series LEDs.

Lumen Maintenance

Cree Venture uses standardized IES LM-80-08 and TM-21-11 methods for collecting long-term data and extrapolating LED lumen maintenance. For information on the specific LM-80 data sets available for this LED, refer to the public J Series LM-80 results document.

Please read the Thermal Management application note for details on how thermal design, ambient temperature, and drive current affect the LED junction temperature.

Moisture Sensitivity

Cree Venture recommends keeping J Series 2835 LEDs in the provided, resealable moisture-barrier packaging (MBP) until immediately prior to soldering. Unopened MBP that contains J Series 2835 LEDs does not need special storage for moisture sensitivity.

Once the MBP is opened, J Series 2835 LEDs should be handled and stored as MSL 3 per JEDEC J-STD-033, meaning they have limited exposure time before damage to the LED may occur during the soldering operation. The table on the right specifies the maximum exposure time in days depending on temperature and humidity conditions. LEDs with exposure time longer than the specified maximums must be baked according to the baking conditions listed below.

Moisture Sensitivity	Temp.	Maximum Percent Relative Humidity					
Level		50%	60%	70%	80%	90%	
Level 3	35 °C	8	5	1	0.5	0.5	
Level 3	30 °C	11	7	1	1	1	
Level 3	25 °C	14	10	2	1	1	
Level 3	20 °C	20	13	2	1	1	

Baking Conditions

It is not necessary to bake all J Series 2835 LEDs. Only the LEDs that meet all of the following criteria must be baked:

- 1. LEDs that have been removed from the original MBP.
- LEDs that have been exposed to a humid environment longer than listed in the Moisture Sensitivity section above.
- LEDs that have not been soldered.

LEDs should be baked at 60 °C for 24 hours. LEDs may be baked in the original reels. Remove LEDs from the MBP before baking. Do not bake parts at temperatures higher than 60 °C. This baking operation resets the exposure time as defined in the Moisture Sensitivity section above.



NOTES - CONTINUED

Vision Advisory

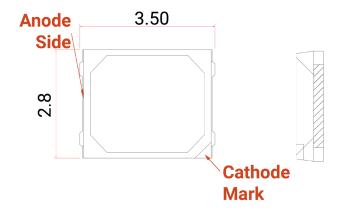
WARNING: Do not look at an exposed lamp in operation. Eye injury can result. For more information about LEDs and eye safety, please refer to the J Series LED Eye Safety application note.

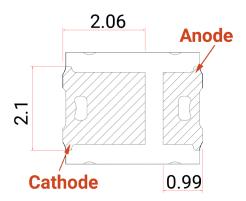


MECHANICAL DIMENSIONS

Vias, if present, are not shown on these drawings.

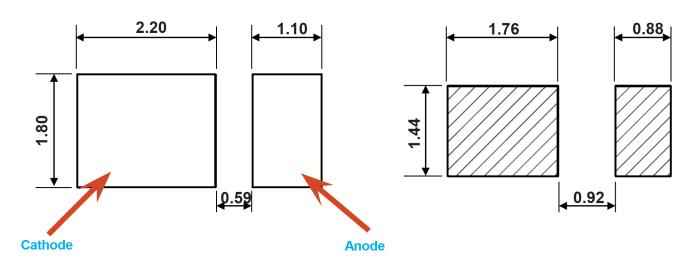
All measurements are ±0.1 mm unless otherwise indicated.





0.70

All measurements are ±0.1 mm unless otherwise indicated.



Recommended PCB Solder Pad

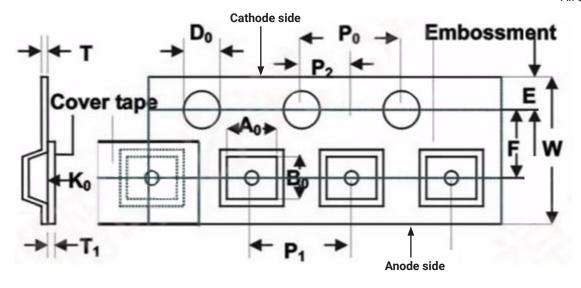
Recommended Stencil Pattern



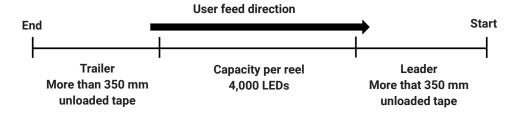
TAPE & REEL

All Cree Venture carrier tapes conform to EIA-481D, Automated Component Handling Systems Standard.

All dimensions in mm.

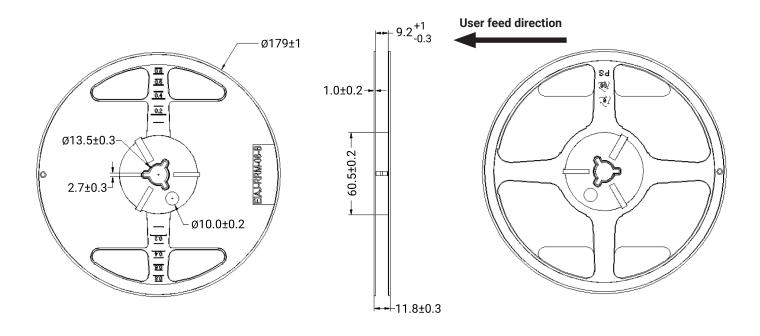


Symbol	Specification	Symbol	Specification
W	8.00 ± 0.10	A ₀	3.00 ± 0.10
Е	1.75 ± 0.10	B _o	3.70 ± 0.10
F	3.50 ± 0.05	K ₀	1.05 ± 0.10
D _o	1.55 ± 0.10		
P_0	4.00 ± 0.10		
P ₁	4.00 ± 0.10		
P_2	2.00 ± 0.05		
Т	0.20 ± 0.05		
T1	0.05 ± 0.01		





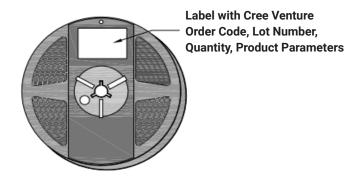
TAPE & REEL- CONTINUED



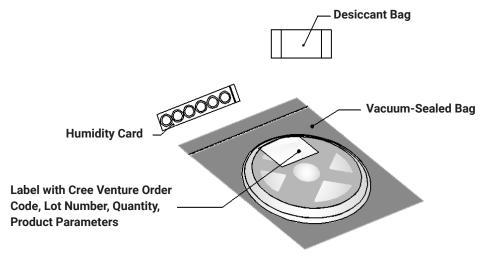


PACKAGING

Unpackaged Reel



Packaged Reel





PACKAGING - CONTINUED

J Series 2835 LEDs are packaged in boxes for shipment. Box sizes and the number of reels per box are as follows.

Вох	Box Dimensions	Maximum Number of Reels per Box
1	250 x 210 x 30 mm	2
2	250 x 210 x 50 mm	4
3	530 x 230 x 275 mm	42
4	530 x 443 x 275 mm	84

Each box has at least one label (shown as a white square in the diagrams below) showing the order code, lot number, quantity, and product parameters.

Box 1

